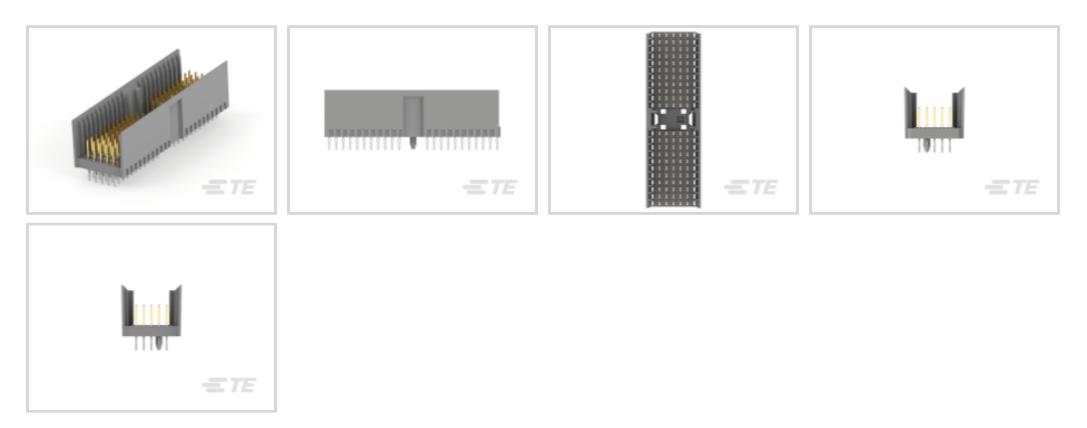


Z-PACK | Z-PACK 2mm HM

TE Internal #: 2391870-1 Z-PACK 2mm HM, Hard Metric Backplane Connectors, PCB Mount Header, ≤1 Gb/s, 22 Column, 5 Row, Mezzanine, Board-to-Board, 110 Position

View on TE.com >

Connectors > PCB Connectors > Backplane Connectors > Hard Metric Connectors



PCB Connector Assembly Type: PCB Mount Header

Data Rate: **≤1 Gb/s**

Number of Columns: 22

Number of Rows: 5

Backplane Architecture: Mezzanine

Features

E

Product Type Features

Backplane Interface Type	2mm HM
PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Rows Loaded	A, B, C, D, E
Number of Columns	22
Number of Rows	5
Backplane Architecture	Mezzanine
Number of Positions	110
PCB Mount Orientation	Vertical
Signal Characteristics	
Crosstalk Version	Standard

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Data Rate	≤1 Gb/s
Contact Features	
Feedthrough Post Length	3.7 mm
Contact Type	Pin
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
CompactPCI Designation	None
Contact Mating Area Plating Material	Performance Based
Contact Current Rating (Max)	1.5 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Front Mating Level	Level 1
Mating Alignment Type	Multi-Purpose Center
Connector Mounting Type	Board Mount

Housing Features

Housing Material	PBT GF
Centerline (Pitch)	2 mm[.078 in]
Housing Color	Gray
Dimensions	
Backplane Module Length	50 mm
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Shielded	No
Circuit Application	Signal
Industry Standards	
AdvancedTCA Specified Product	No
Packaging Features	
Packaging Method	Tray

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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not reviewed for solder process capability

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

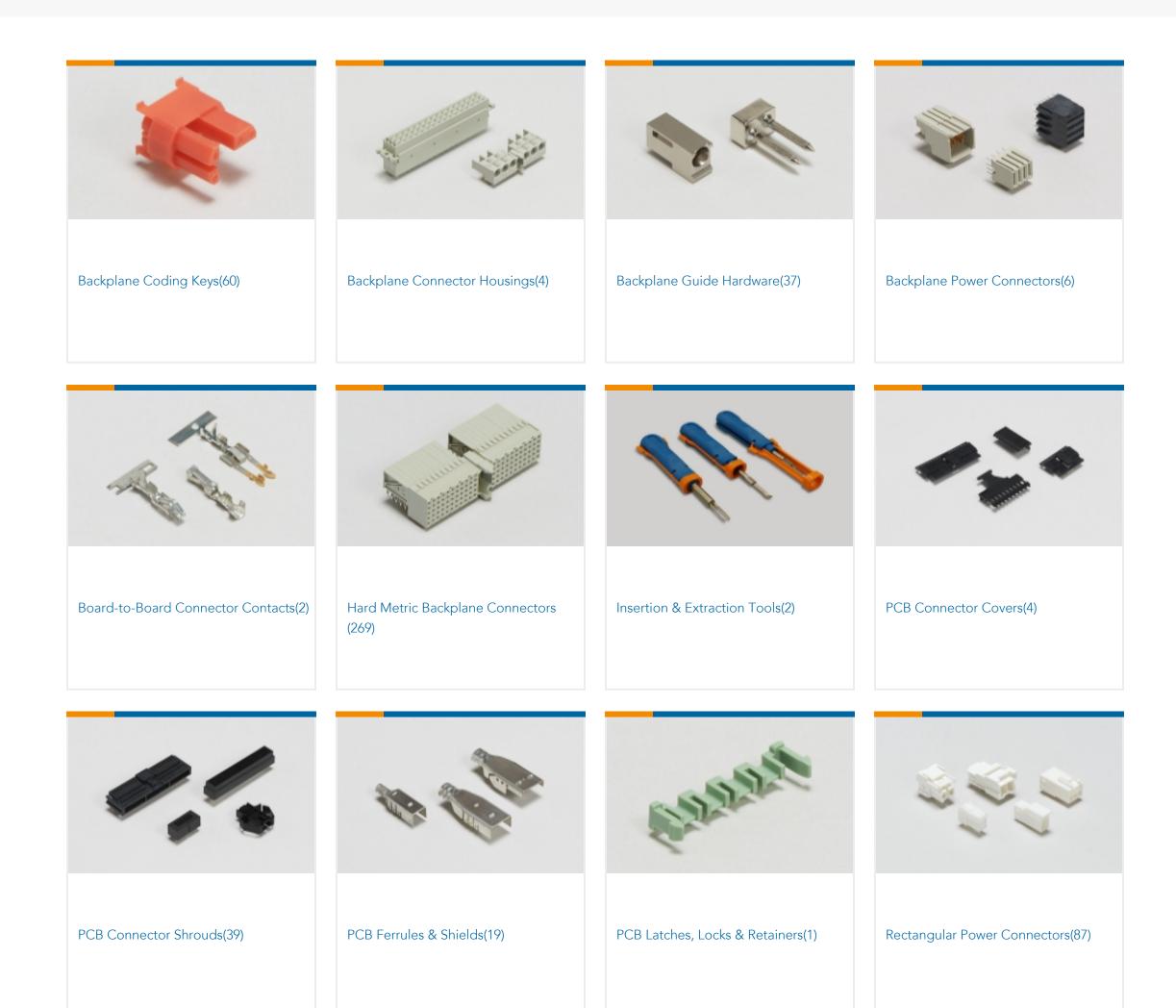
Compatible Parts



Also in the Series Z-PACK 2mm HM

Z-PACK 2mm HM, Hard Metric Backplane Connectors, PCB Mount Header, ≤1 Gb/s, 22 Column, 5 Row, Mezzanine, Board-to-Board, 110 Position





Documents

Product Drawings 2MM H.M. TYPE "A" PIN ASSY.EON

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_2391870-1_1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2391870-1_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2391870-1_1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Z-PACK 2mm HM, Hard Metric Backplane Connectors, PCB Mount Header, ≤1 Gb/s, 22 Column, 5 Row, Mezzanine, Board-to-Board, 110 Position



Product Specifications Application Specification

English